

N-Channel MOSFET Transistor

- FEATURES

- Drain Source Voltage-
: $V_{DSS} = 60V(\text{Min})$
- Static Drain-Source On-Resistance
: $R_{DS(on)} = 22m\Omega (\text{Max})$
- Fast Switching
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

- APPLICATIONS

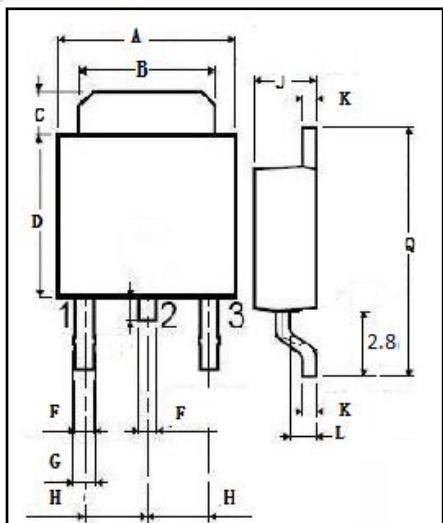
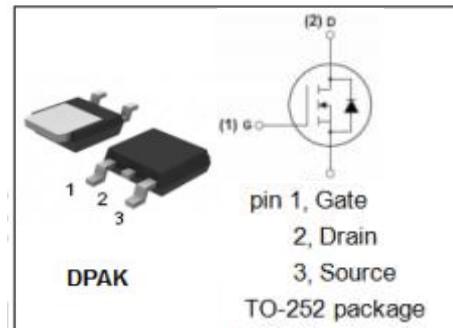
- High current , high speed switching
- Switch mode power supplies
- DC-DC converters for telecom, industrial, and lighting equipment ideal for monitor's B+ function

- ABSOLUTE MAXIMUM RATINGS($T_a=25^\circ\text{C}$)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage-Continuous	± 25	V
I_D	Drain Current-Continuous	50	A
I_{DM}	Drain Current-Single Plused	200	A
P_D	Total Dissipation @ $T_c=25^\circ\text{C}$	83	W
T_j	Max. Operating Junction Temperature	-55~175	°C
T_{stg}	Storage Temperature	-55~175	°C

- THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th j-c}$	Thermal Resistance, Junction to Case	1.8	°C/W



mm		
DIM	MIN	MAX
A	6.4	6.6
B	5.2	5.4
C	1.3	1.7
D	5.2	5.7
F	0.6	0.7
G	0.65	0.75
H	2.1	2.5
J	2.1	2.4
K	0.4	0.6
L	0.9	1.1
Q	9.5	10

• ELECTRICAL CHARACTERISTICS

$T_c=25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	MAX	UNIT
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}= 0$; $I_D=250\mu\text{A}$	60			V
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}= V_{GS}$; $I_D=250\mu\text{A}$	2		4	V
$R_{DS(\text{on})}$	Drain-Source On-Resistance	$V_{GS}= 10\text{V}$; $I_D= 25\text{A}$			22	$\text{m}\Omega$
I_{GSS}	Gate-Body Leakage Current	$V_{GS}= \pm 25\text{V}$; $V_{DS}= 0$			± 100	nA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=60\text{V}$; $V_{GS}= 0$ $V_{DS}=48\text{V}$; $V_{GS}= 0$; $T_c=150^\circ\text{C}$			1 10	μA
V_{SD}	Diode Forward On-voltage	$I_F= 50\text{A}$; $V_{GS}= 0$			1.5	V